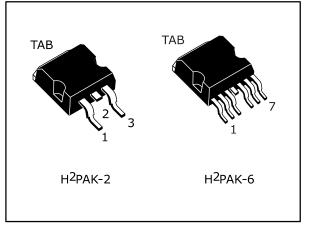
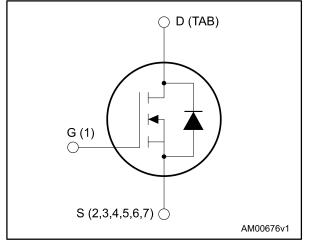
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# N-channel 60 V, 0.0028 $\Omega$ typ., 80 A STripFET $^{\rm M}$ F7 Power MOSFETs in H²PAK-2 and H²PAK-6 packages

Datasheet - production data



#### Figure 1: Internal schematic diagram



This is information on a product in full production.

### **Features**

Order code	VDS	R <sub>DS(on)</sub> max.	ΙD	Ртот
STH140N6F7-2	60 V	0.0032 Ω	80 A	158 W
STH140N6F7-6	60 V	0.0032 12	60 A	100 10

- Among the lowest R<sub>DS(on)</sub> on the market
- Excellent figure of merit (FoM)
- Low Crss/Ciss ratio for EMI immunity
- High avalanche ruggedness

### **Applications**

• Switching applications

### Description

This N-channel Power MOSFET utilizes STripFET<sup>™</sup> F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

#### Table 1: Device summary

Order code	Marking	Package	Packing			
STH140N6F7-2	140N6F7	H <sup>2</sup> PAK-2	Tape and Reel			
STH140N6F7-6	140N6F7	H²PAK-6	Tape and Reel			

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### 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vds	Drain-source voltage	60	V
V <sub>GS</sub>	Gate-source voltage	±20	V
D <sup>(1)</sup>	Drain current (continuous) at T <sub>case</sub> = 25 °C	80	٥
ID.	Drain current (continuous) at T <sub>case</sub> = 100 °C	80	A
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	320	А
Ртот	Total dissipation at T <sub>case</sub> = 25 °C	158	W
T <sub>stg</sub>	Storage temperature	-55 to 175	℃
Tj	Maximum junction temperature	175	

### Notes:

<sup>(1)</sup> Current is limited by package.

 $^{\left( 2\right) }$  Pulse width is limited by safe operating area.

Table 3: Thermal data
-----------------------

Symbol	Parameter	Value	Unit
Rthj-pcb <sup>(1)</sup>	Thermal resistance junction-pcb	35	°C/W
R <sub>thj</sub> -case	Thermal resistance junction-case	0.95	°C/W

#### Notes:

 $^{(1)}$  When mounted on a 1-inch² FR-4, 2 oz Cu board.



### 2 Electrical characteristics

(T<sub>case</sub> = 25 °C unless otherwise specified)

Table 4: Static							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS} = 0 V$ , $I_D = 1 mA$	60			V	
	Zoro goto voltogo drain	$V_{GS} = 0 V, V_{DS} = 60 V$			1		
IDSS	Zero gate voltage drain current	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 60 V, T <sub>case</sub> = 125 °C			100	μA	
Igss	Gate-body leakage current	$V_{DS} = 0 V, V_{GS} = +20 V$			100	nA	
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2		4	V	
R <sub>DS(on)</sub>	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 40 \text{ A}$		0.0028	0.0032	Ω	

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	3100	-	
Coss	Output capacitance	$V_{DS} = 25 V, f = 1 MHz, V_{GS} = 0 V$	-	1520	-	pF
Crss	Reverse transfer capacitance	-		193	-	
Qg	Total gate charge		-	55	-	
Qgs	Gate-source charge	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 80 A, V <sub>GS</sub> = 10 V (see <i>Figure 14: "Gate charge test circuit"</i> )	-	19	-	nC
$Q_{gd}$	Gate-drain charge		-	18	-	

#### Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 40 \text{ A} \text{ R}_{G} = 4.7 \Omega,$	-	24	-	
tr	Rise time	V <sub>GS</sub> = 10 V (see Figure 13: "Switching times test circuit for	-	68	-	
t <sub>d(off)</sub>	Turn-off delay time	resistive load" and Figure 18:	-	39	-	ns
t <sub>f</sub>	Fall time	"Switching time waveform")	-	20	-	



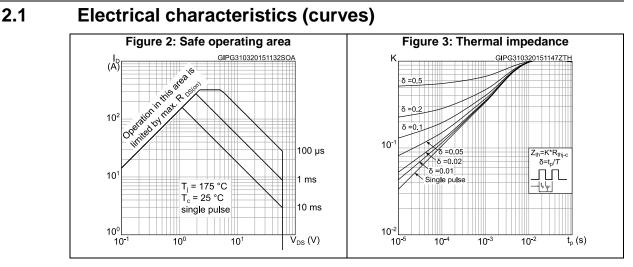
### Electrical characteristics

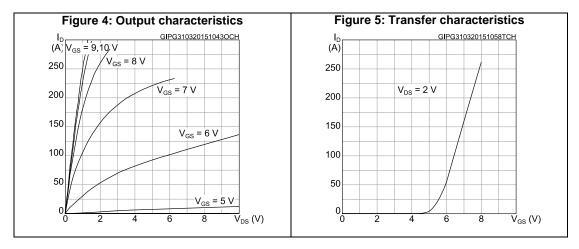
Table 7: Source-drain diode						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage	$V_{GS} = 0 V, I_{SD} = 80 A$	-		1.2	V
trr	Reverse recovery time	I <sub>SD</sub> = 80 A, di/dt = 100 A/µs,	-	42.4		ns
Qrr	Reverse recovery charge	V <sub>DD</sub> = 48 V (see Figure 15: "Test circuit for inductive load switching	-	38.2		nC
Irrm	Reverse recovery current	and diode recovery times")	-	1.8		А

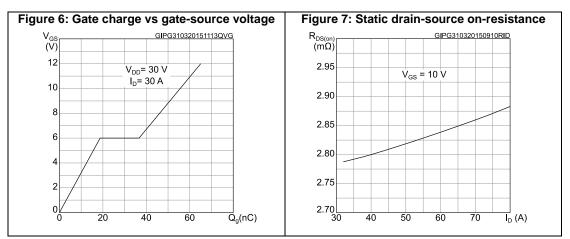
### Notes:

 $^{(1)}$  Pulse test: pulse duration = 300  $\mu s,$  duty cycle 1.5%.





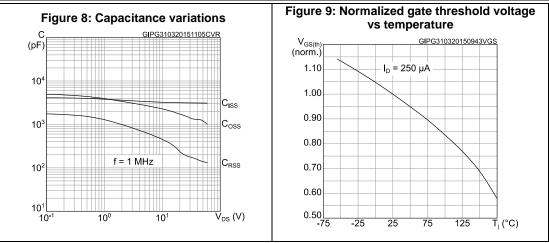


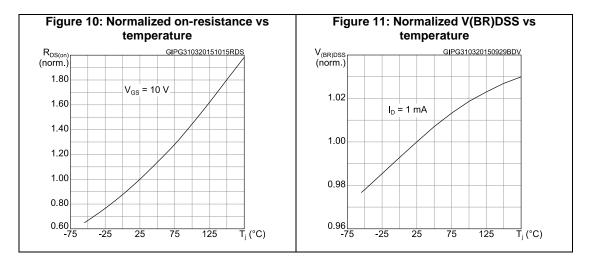


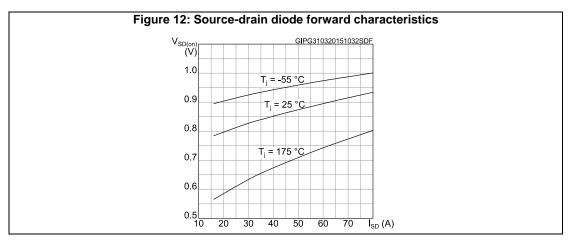
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#### **Electrical characteristics**

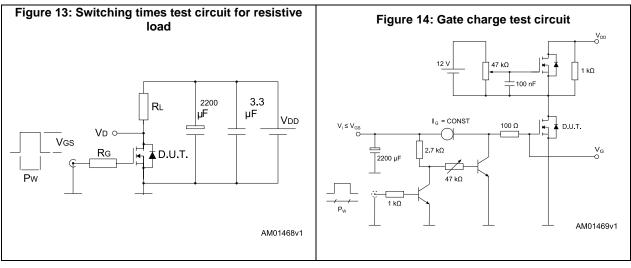


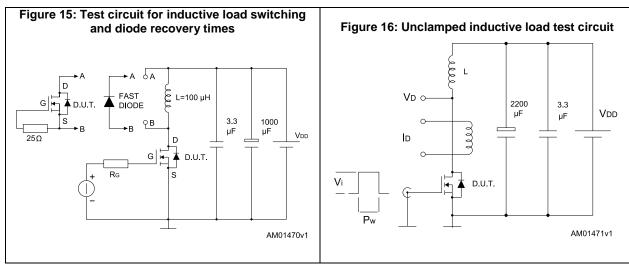


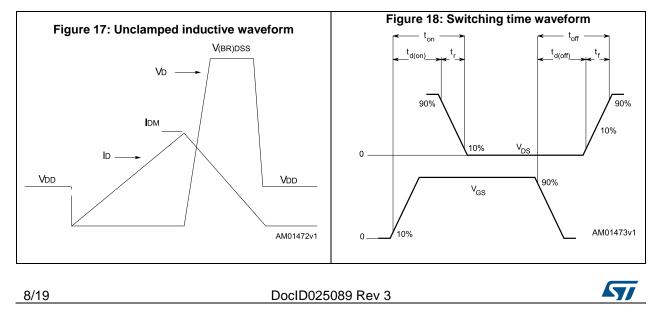




### 3 Test circuits





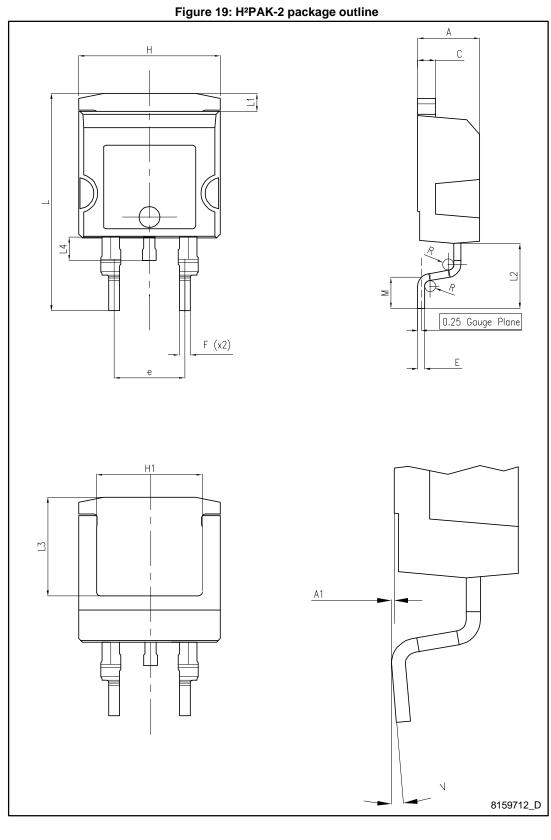


### 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



### 4.1 H<sup>2</sup>PAK-2 package information



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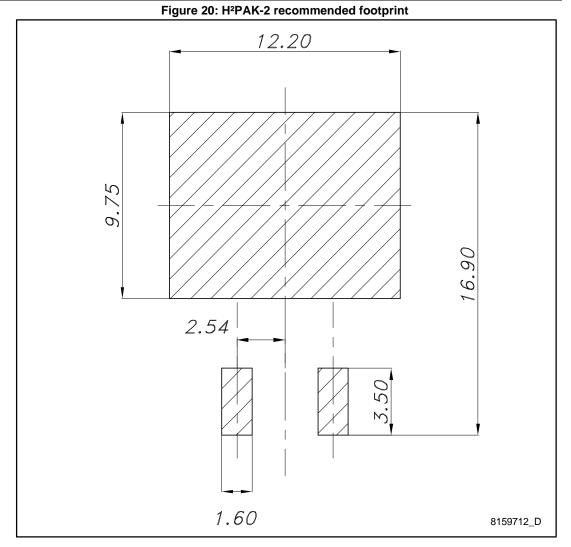
### Package information

	Table 8: H <sup>2</sup> PAK-2 package mechanical data					
Dim.		mm				
Dini.	Min.	Тур.	Max.			
A	4.30		4.80			
A1	0.03		0.20			
С	1.17		1.37			
е	4.98		5.18			
E	0.50		0.90			
F	0.78		0.85			
н	10.00		10.40			
H1	7.40		7.80			
L	15.30	-	15.80			
L1	1.27		1.40			
L2	4.93		5.23			
L3	6.85		7.25			
L4	1.5		1.7			
М	2.6		2.9			
R	0.20		0.60			
V	0°		8°			



Package information

STH140N6F7-2, STH140N6F7-6





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### 4.2 H<sup>2</sup>PAK-6 package information

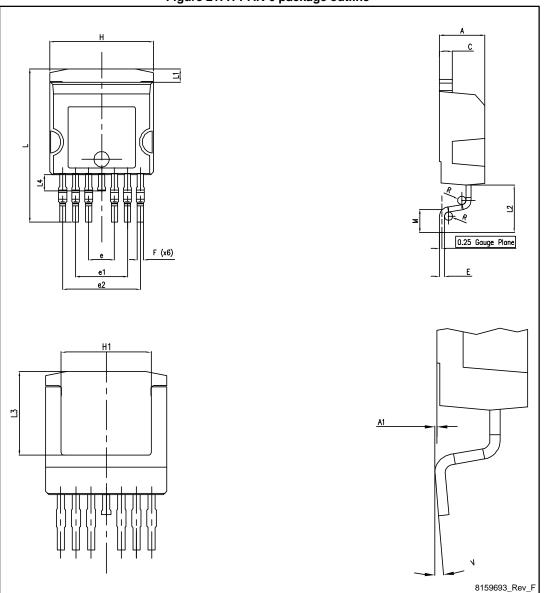


Figure 21: H<sup>2</sup>PAK-6 package outline



### Package information

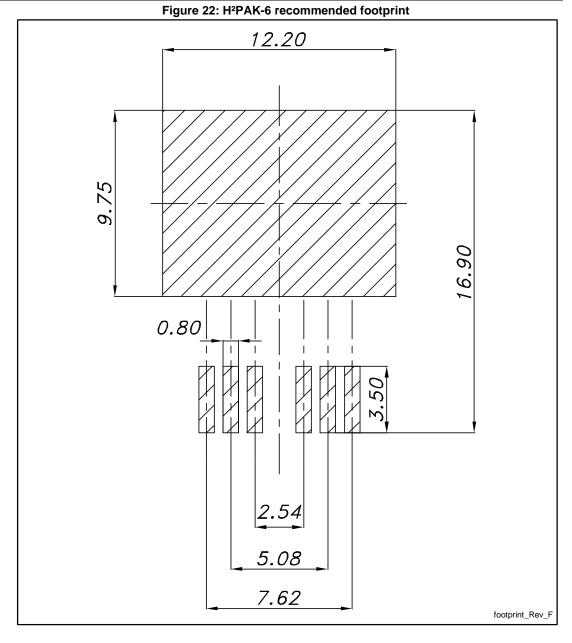
# STH140N6F7-2, STH140N6F7-6 echanical data

nformation	Ition STH140N6F7-2, STH140N6F7-6				
	Table 9: H <sup>2</sup> PAK-6 packa	ge mechanical data			
Dim	mm				
Dim.	Min.	Тур.	Max.		
A	4.30		4.80		
A1	0.03		0.20		
С	1.17		1.37		
е	2.34		2.74		
e1	4.88		5.28		
e2	7.42		7.82		
E	0.45		0.60		
F	0.50		0.70		
Н	10.00		10.40		
H1	7.40	-	7.80		
L	14.75		15.25		
L1	1.27		1.40		
L2	4.35		4.95		
L3	6.85		7.25		
L4	1.5		1.75		
М	1.90		2.50		
R	0.20		0.60		
V	0°		8°		

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### Package information





Dimensions are in mm.



4.3 H<sup>2</sup>PAK packing information

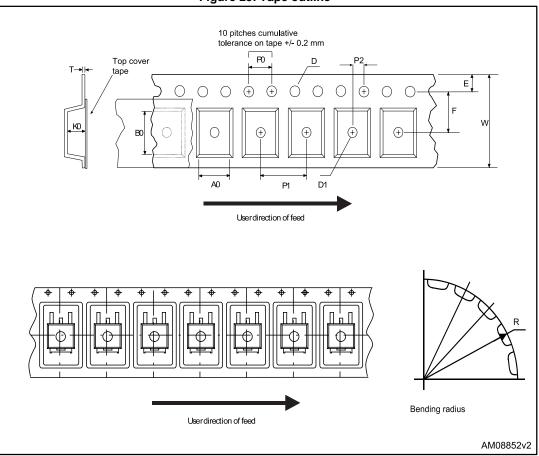
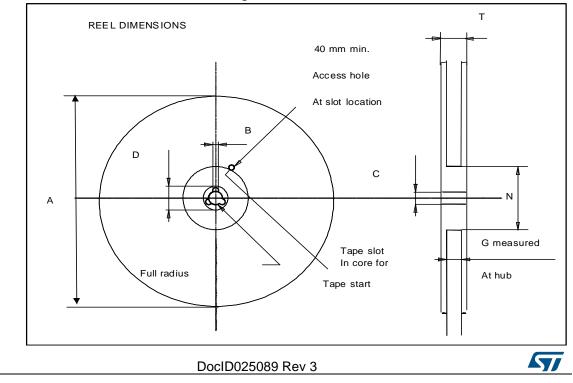


Figure 23: Tape outline

Figure 24: Reel outline



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### Package information

Table 10: Tape and reel mechanical data						
Таре			Reel			
Dim.	mm		Dim.	mm		
	Min.	Max.	Dim.	Min.	Max.	
A0	10.5	10.7	А		330	
B0	15.7	15.9	В	1.5		
D	1.5	1.6	С	12.8	13.2	
D1	1.59	1.61	D	20.2		
E	1.65	1.85	G	24.4	26.4	
F	11.4	11.6	N	100		
K0	4.8	5.0	Т		30.4	
P0	3.9	4.1				
P1	11.9	12.1	Base quantity		1000	
P2	1.9	2.1	Bulk quantity 1000		1000	
R	50					
Т	0.25	0.35				
W	23.7	24.3				



### 5 Revision history

Table 11: Document revision history

Date	Revision	Changes		
02-Aug-2013	1	Initial release.		
01-Apr-2015	2	<ul> <li>Throughout document:</li> <li>minor text changes</li> <li>added H<sup>2</sup>PAK-6 package information.</li> <li>removed TO-220FP and TO-220 package information.</li> <li>In Section 1 Electrical ratings:</li> <li>updated Table 2. Absolute maximum ratings</li> <li>updated Table 3. Thermal data</li> <li>In Section 2 Electrical characteristics:</li> <li>updated and renamed Table 4. Static (was "On /off states")</li> <li>updated Table 5. Dynamic</li> <li>updated Table 6. Switching times</li> <li>updated Table 7. Source drain diode</li> <li>added Section 2.1 Electrical characteristics (curves)</li> </ul>		
16-Jul-2015	3	Document status promoted from preliminary to production data.		



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